Thermal GP1000ÿ?ìWm&¬

Features

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l GP1000 thermal conductive silicone gap pad is a kind of material

ermal conductivity. Owing to double-sided nat

build up a good heat conduction path between the heat sink and

substrate during assembly. The product shows low thermal

nd good electrical insulation properties under low compression

Property Az/(	Typical Value y&Œ =	Unit "V N	Test Method <LZÖ4º;Ö
Composition <X,1 !	Silicone Filled with Thermal Powder GDOõ‰?ìKˆ R		—
Color g•Os	Gray ?oQq	—	Visual EíXÅ
Thermal Conductivity *ý?ìKü4q	10.0	W/m·K	

All technical information stated in this technical data have been confirmed that all the technical parameters are reliable after hard testing and evaluation of the products. Before you use our products, please carefully evaluate and decide whether the product meets your requirement and you need to take all the risks and responsibilities to use.

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